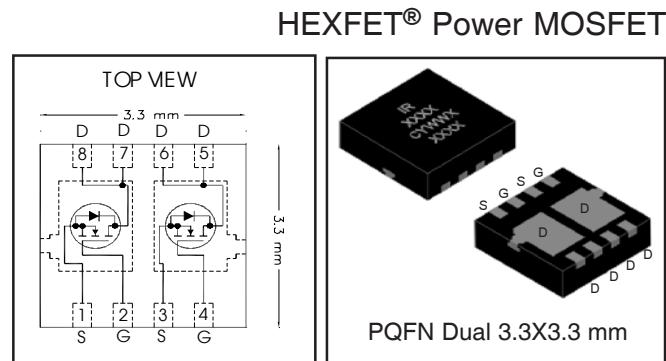


<b>V<sub>DS</sub></b>	<b>100</b>	<b>V</b>
<b>V<sub>GS</sub> max</b>	<b>± 20</b>	<b>V</b>
<b>R<sub>DS(on)</sub> max (@V<sub>GS</sub> = 10V)</b>	<b>195</b>	<b>mΩ</b>
<b>Q<sub>g typ</sub></b>	<b>4.2</b>	<b>nC</b>
<b>I<sub>D</sub> (@T<sub>c(Bottom)</sub> = 25°C)</b>	<b>3.4⑥</b>	<b>A</b>



## Applications

- DC-DC Primary Switch
- 48V Battery Monitoring

## Features and Benefits

### Features

Low RDSon (<195mΩ)
Low Thermal Resistance to PCB (< 12°C/W)
Low Profile (<1.2mm)
Industry-Standard Pinout
Compatible with Existing Surface Mount Techniques
RoHS Compliant Containing no Lead, no Bromide and no Halogen
MSL1, Industrial Qualification

### Benefits

Lower Conduction Losses
Enable better thermal dissipation
Increased Power Density
Multi-Vendor Compatibility
Easier Manufacturing
Environmentally Friendlier
Increased Reliability

results in  
⇒

Orderable part number	Package Type	Standard Pack		Note
		Form	Quantity	
IRFHM792TRPBF	PQFN Dual 3.3mm x 3.3mm	Tape and Reel	4000	
IRFHM792TP2PBF	PQFN Dual 3.3mm x 3.3mm	Tape and Reel	400	EOL notice # 259

## Absolute Maximum Ratings

	Parameter	Max.	Units
V <sub>DS</sub>	Drain-to-Source Voltage	100	V
V <sub>GS</sub>	Gate-to-Source Voltage	± 20	
I <sub>D</sub> @ T <sub>A</sub> = 25°C	Continuous Drain Current, V <sub>GS</sub> @ 10V	2.3	A
I <sub>D</sub> @ T <sub>A</sub> = 70°C	Continuous Drain Current, V <sub>GS</sub> @ 10V	1.8	
I <sub>D</sub> @ T <sub>C(Bottom)</sub> = 25°C	Continuous Drain Current, V <sub>GS</sub> @ 10V	4.8 ⑥	
I <sub>D</sub> @ T <sub>C(Bottom)</sub> = 100°C	Continuous Drain Current, V <sub>GS</sub> @ 10V	3.1	
I <sub>D</sub> @ T <sub>C</sub> = 25°C	Continuous Drain Current, V <sub>GS</sub> @ 10V (Wirebond Limited)	3.4⑥	
I <sub>DM</sub>	Pulsed Drain Current ①	14	W
P <sub>D</sub> @ T <sub>A</sub> = 25°C	Power Dissipation ⑤	2.3	
P <sub>D</sub> @ T <sub>C(Bottom)</sub> = 25°C	Power Dissipation ⑤	10.4	
	Linear Derating Factor ⑤	0.018	W/°C
T <sub>J</sub> T <sub>STG</sub>	Operating Junction and Storage Temperature Range	-55 to + 150	°C

Notes ① through ⑥ are on page 9

**Static @  $T_J = 25^\circ\text{C}$  (unless otherwise specified)**

	Parameter	Min.	Typ.	Max.	Units	Conditions
$\text{BV}_{\text{DSS}}$	Drain-to-Source Breakdown Voltage	100	—	—	V	$V_{\text{GS}} = 0\text{V}, I_D = 250\mu\text{A}$
$\Delta \text{BV}_{\text{DSS}}/\Delta T_J$	Breakdown Voltage Temp. Coefficient	—	0.11	—	V/ $^\circ\text{C}$	Reference to $25^\circ\text{C}$ , $I_D = 1.0\text{mA}$
$R_{\text{DS(on)}}$	Static Drain-to-Source On-Resistance	—	164	195	$\text{m}\Omega$	$V_{\text{GS}} = 10\text{V}, I_D = 2.9\text{A}$ ③
$V_{\text{GS(th)}}$	Gate Threshold Voltage	2.0	3.0	4.0	V	$V_{\text{DS}} = V_{\text{GS}}, I_D = 10\mu\text{A}$
$\Delta V_{\text{GS(th)}}$	Gate Threshold Voltage Coefficient	—	-8.2	—	$\text{mV}/^\circ\text{C}$	
$I_{\text{DSS}}$	Drain-to-Source Leakage Current	—	—	20	$\mu\text{A}$	$V_{\text{DS}} = 100\text{V}, V_{\text{GS}} = 0\text{V}$
		—	—	250	mA	$V_{\text{DS}} = 100\text{V}, V_{\text{GS}} = 0\text{V}, T_J = 125^\circ\text{C}$
$I_{\text{GSS}}$	Gate-to-Source Forward Leakage	—	—	100	nA	$V_{\text{GS}} = 20\text{V}$
	Gate-to-Source Reverse Leakage	—	—	-100	nA	$V_{\text{GS}} = -20\text{V}$
$g_{\text{fs}}$	Forward Transconductance	3.5	—	—	S	$V_{\text{DS}} = 50\text{V}, I_D = 2.9\text{A}$
$Q_g$	Total Gate Charge	—	4.2	6.3	nC	
$Q_{\text{gs}1}$	Pre-V <sub>th</sub> Gate-to-Source Charge	—	0.7	—		$V_{\text{DS}} = 50\text{V}$
$Q_{\text{gs}2}$	Post-V <sub>th</sub> Gate-to-Source Charge	—	0.3	—		$V_{\text{GS}} = 10\text{V}$
$Q_{\text{gd}}$	Gate-to-Drain Charge	—	1.3	—		$I_D = 2.9\text{A}$
$Q_{\text{godr}}$	Gate Charge Overdrive	—	1.9	—		
$Q_{\text{sw}}$	Switch Charge ( $Q_{\text{gs}2} + Q_{\text{gd}}$ )	—	1.6	—		
$Q_{\text{oss}}$	Output Charge	—	6.7	—	nC	$V_{\text{DS}} = 16\text{V}, V_{\text{GS}} = 0\text{V}$
$R_G$	Gate Resistance	—	1.6	—	$\Omega$	
$t_{\text{d(on)}}$	Turn-On Delay Time	—	3.4	—	ns	$V_{\text{DD}} = 50\text{V}, V_{\text{GS}} = 10\text{V}$
$t_r$	Rise Time	—	4.7	—		$I_D = 2.9\text{A}$
$t_{\text{d(off)}}$	Turn-Off Delay Time	—	5.2	—		$R_G = 1.8\Omega$
$t_f$	Fall Time	—	2.6	—		
$C_{\text{iss}}$	Input Capacitance	—	251	—	pF	$V_{\text{GS}} = 0\text{V}$
$C_{\text{oss}}$	Output Capacitance	—	31	—		$V_{\text{DS}} = 25\text{V}$
$C_{\text{rss}}$	Reverse Transfer Capacitance	—	13	—		$f = 1.0\text{MHz}$

**Avalanche Characteristics**

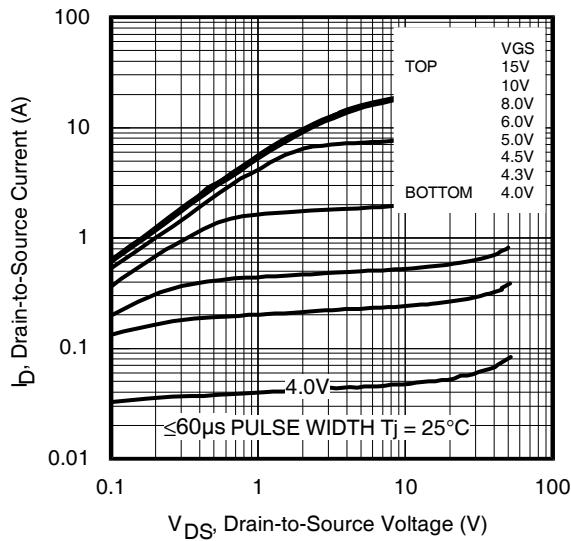
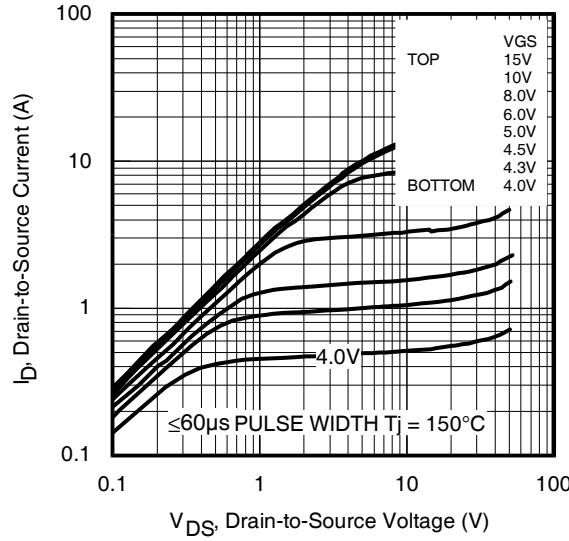
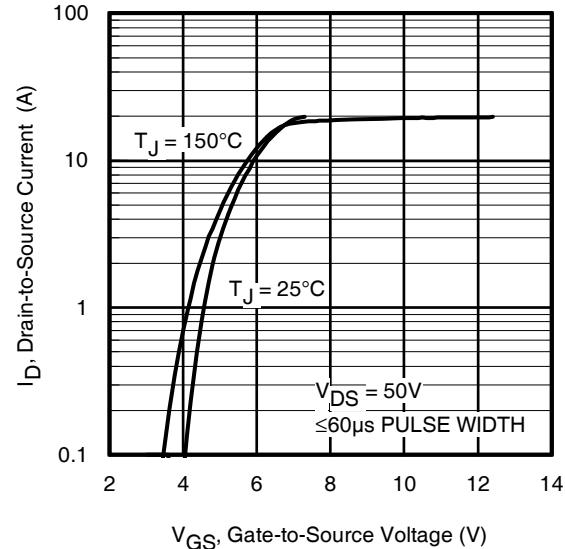
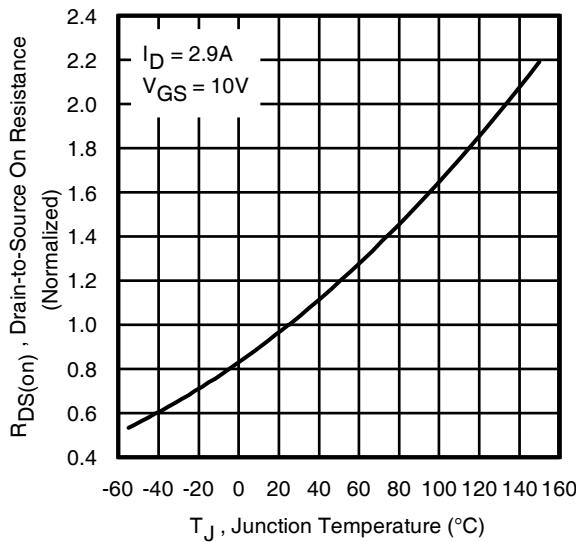
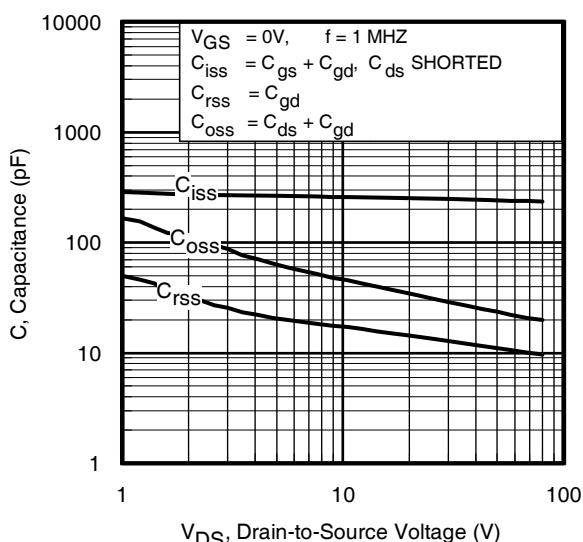
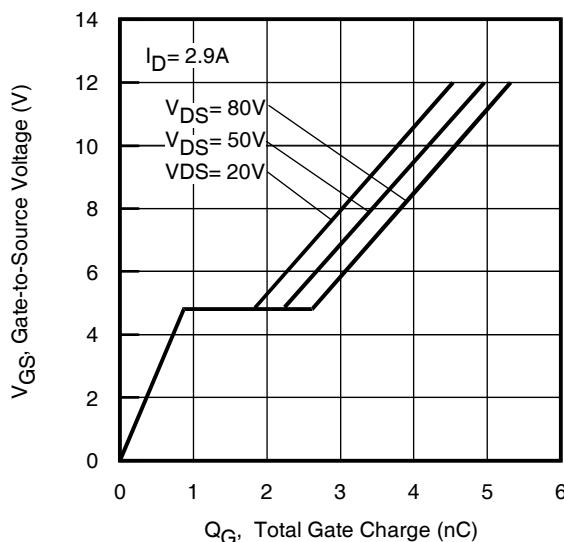
	Parameter	Typ.	Max.	Units
$E_{\text{AS}}$	Single Pulse Avalanche Energy ②	—	10.2	mJ
$I_{\text{AR}}$	Avalanche Current ①	—	2.9	A

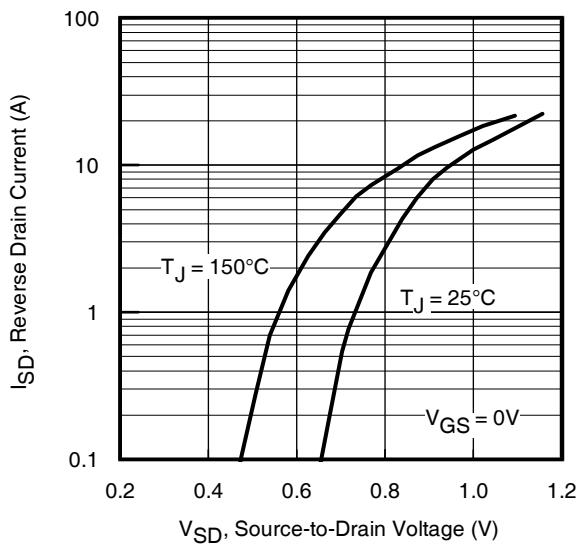
**Diode Characteristics**

	Parameter	Min.	Typ.	Max.	Units	Conditions
$I_S$	Continuous Source Current (Body Diode)	—	—	3.4④	A	MOSFET symbol showing the integral reverse p-n junction diode.
$I_{\text{SM}}$	Pulsed Source Current (Body Diode) ①	—	—	14		
$V_{\text{SD}}$	Diode Forward Voltage	—	—	1.3		$T_J = 25^\circ\text{C}, I_S = 2.9\text{A}, V_{\text{GS}} = 0\text{V}$ ③
$t_{rr}$	Reverse Recovery Time	—	15	23	ns	$T_J = 25^\circ\text{C}, I_F = 2.9\text{A}, V_{\text{DD}} = 50\text{V}$
$Q_{rr}$	Reverse Recovery Charge	—	45	68	nC	$dI/dt = 500\text{A}/\mu\text{s}$ ③
$t_{\text{on}}$	Forward Turn-On Time	Time is dominated by parasitic Inductance				

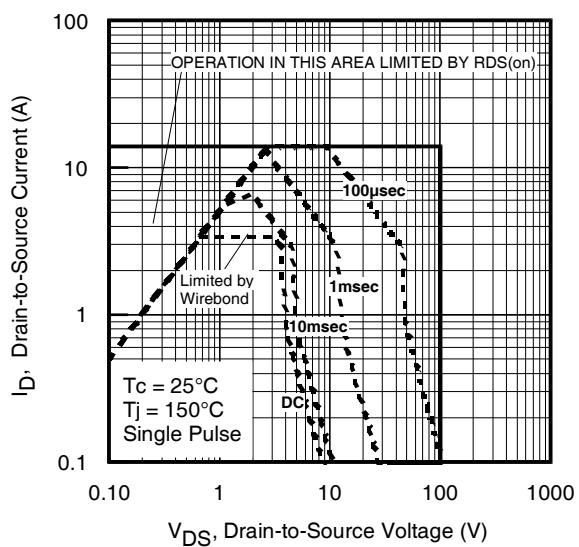
**Thermal Resistance**

	Parameter	Typ.	Max.	Units
$R_{\theta\text{JC}} \text{ (Bottom)}$	Junction-to-Case ④	—	12	°C/W
$R_{\theta\text{JC}} \text{ (Top)}$	Junction-to-Case ④	—	85	
$R_{\theta\text{JA}}$	Junction-to-Ambient ⑤	—	55	
$R_{\theta\text{JA}} \text{ (<10s)}$	Junction-to-Ambient ⑤	—	38	

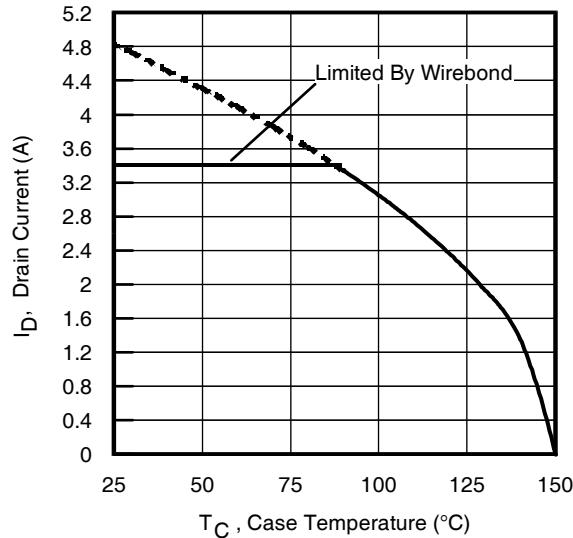
**Fig 1.** Typical Output Characteristics**Fig 2.** Typical Output Characteristics**Fig 3.** Typical Transfer Characteristics**Fig 4.** Normalized On-Resistance vs. Temperature**Fig 5.** Typical Capacitance vs. Drain-to-Source Voltage**Fig 6.** Typical Gate Charge vs. Gate-to-Source Voltage



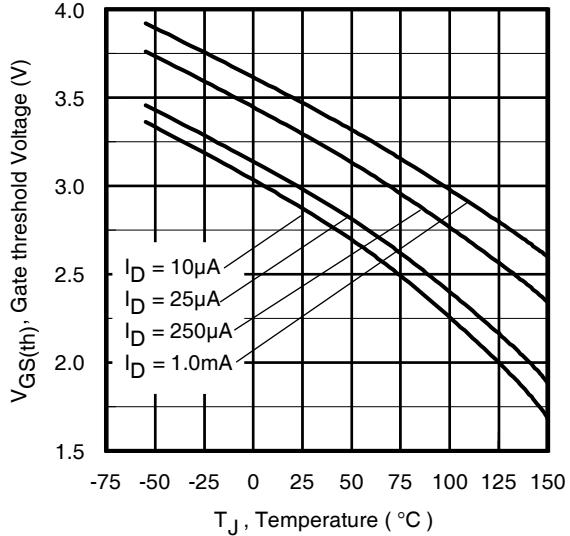
**Fig 7.** Typical Source-Drain Diode Forward Voltage



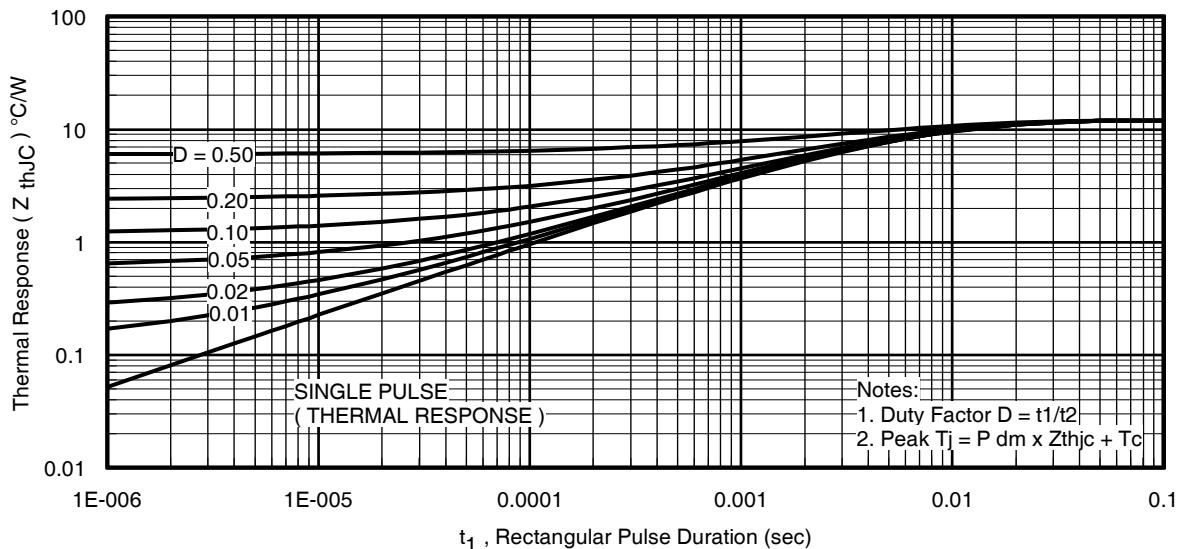
**Fig 8.** Maximum Safe Operating Area



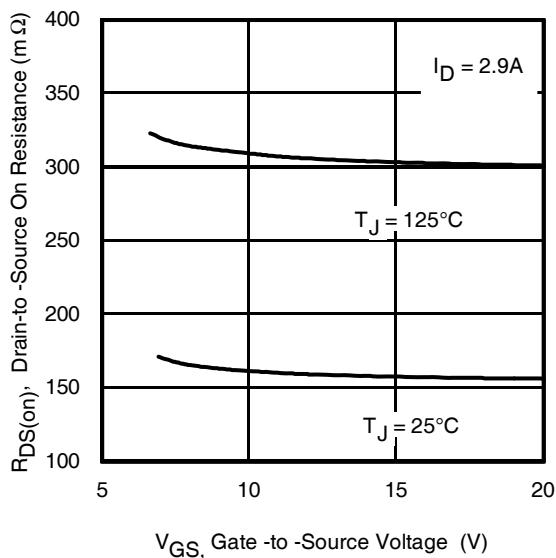
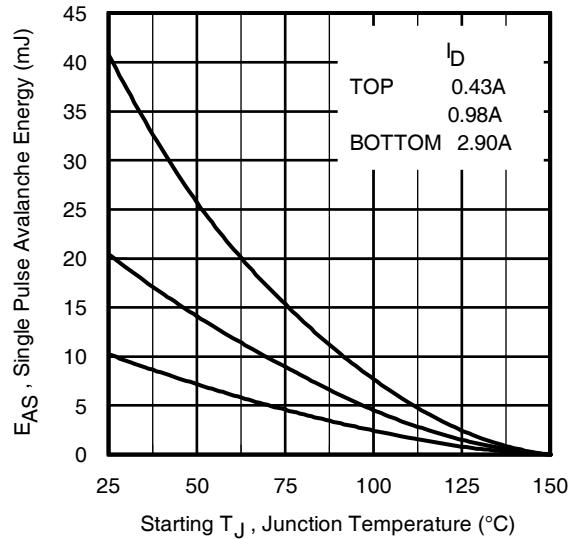
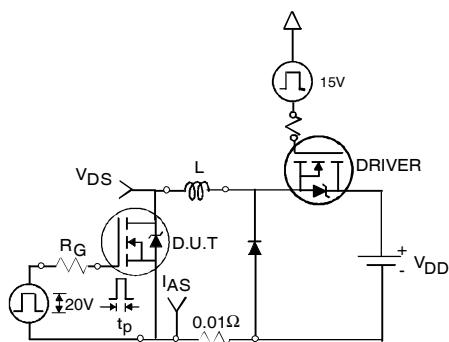
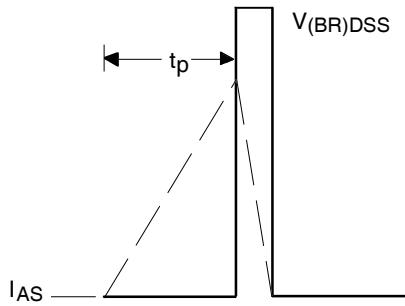
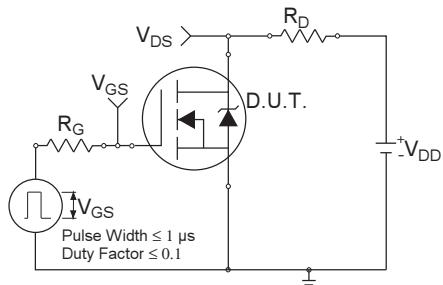
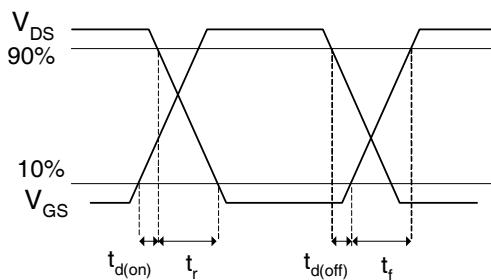
**Fig 9.** Maximum Drain Current vs. Case (Bottom) Temperature

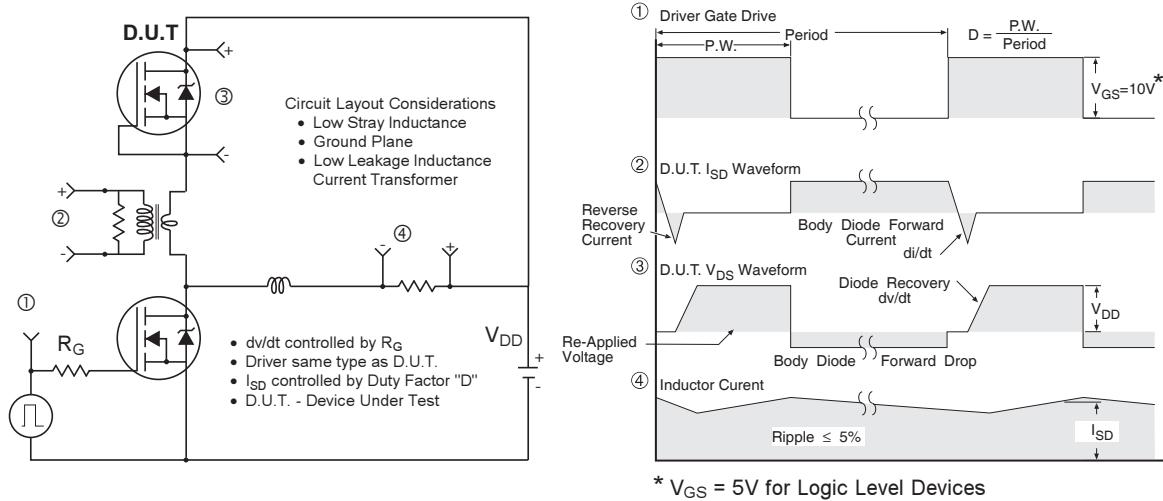


**Fig 10.** Threshold Voltage vs. Temperature

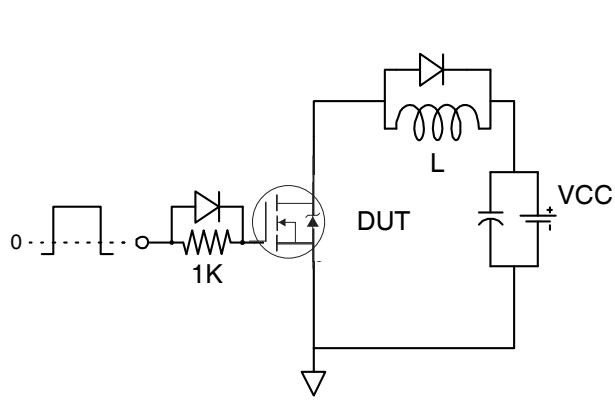


**Fig 11.** Maximum Effective Transient Thermal Impedance, Junction-to-Case (Bottom)

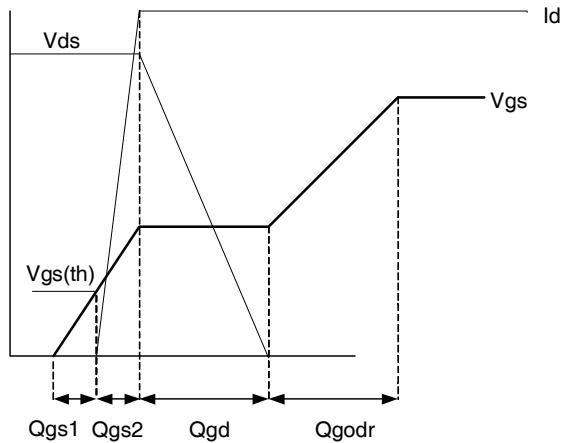
**Fig 12.** On-Resistance vs. Gate Voltage**Fig 13.** Maximum Avalanche Energy vs. Drain Current**Fig 14a.** Unclamped Inductive Test Circuit**Fig 14b.** Unclamped Inductive Waveforms**Fig 15a.** Switching Time Test Circuit**Fig 15b.** Switching Time Waveforms



**Fig 16.** Peak Diode Recovery  $dv/dt$  Test Circuit for N-Channel HEXFET® Power MOSFETs

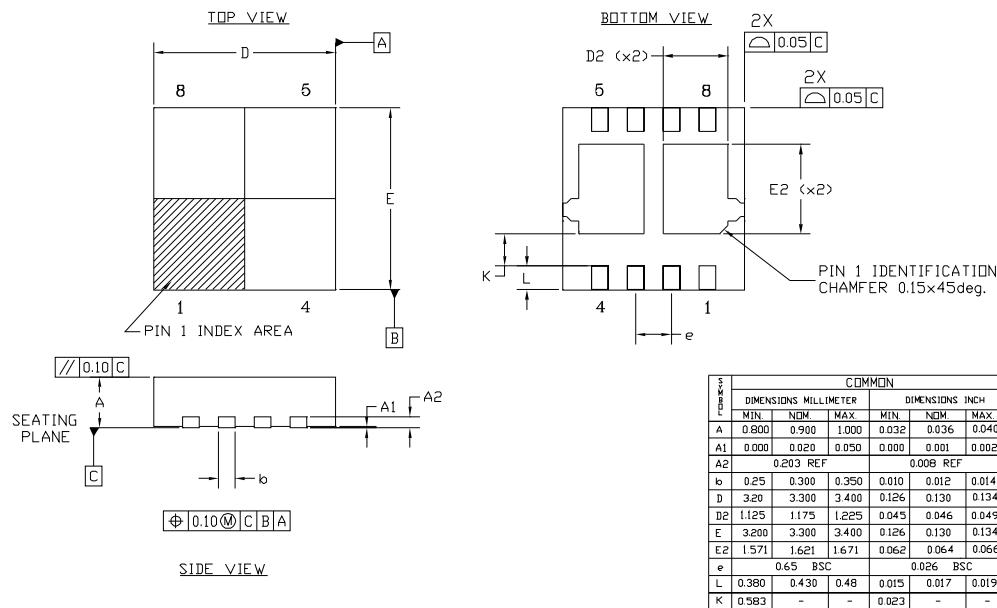


**Fig 17.** Gate Charge Test Circuit



**Fig 18.** Gate Charge Waveform

## PQFN Dual 3.3x3.3 Package Details

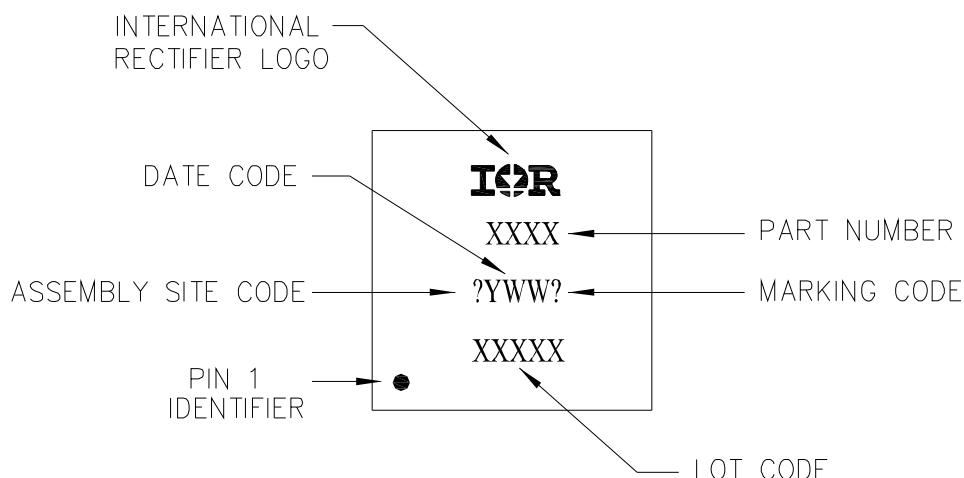


NOTES :

1. DIMENSION AND TOLERANCING CONFORM TO ASME Y14.5M-1994.
2. CONTROLLING DIMENSIONS : MILLIMETER. CONVERTED INCH DIMENSION ARE NOT NECESSARILY EXACT.
3. DIMENSION b APPLIES TO METALLIZED TERMINAL AND IS MEASURED BETWEEN 0.15 AND 0.30 mm FROM TERMINAL TIP.

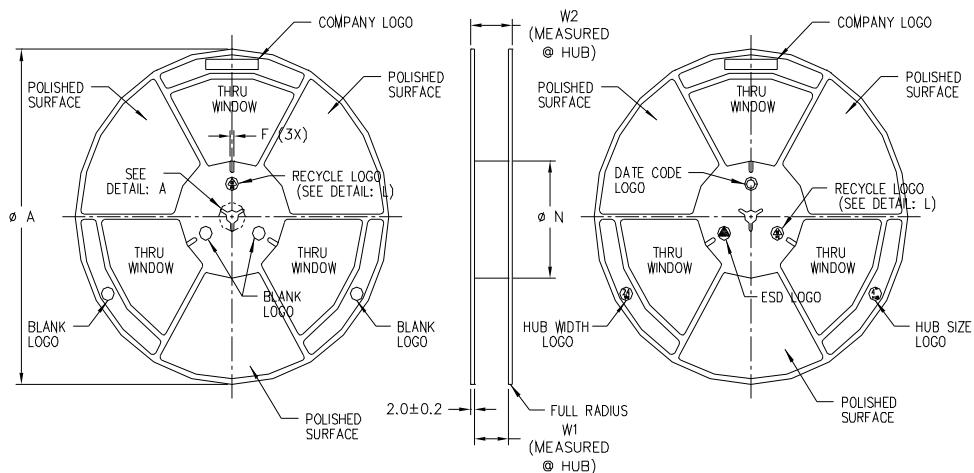
For footprint and stencil design recommendations, please refer to application note AN-1154 at  
<http://www.irf.com/technical-info/appnotes/an-1154.pdf>

## PQFN Dual 3.3x3.3 Part Marking



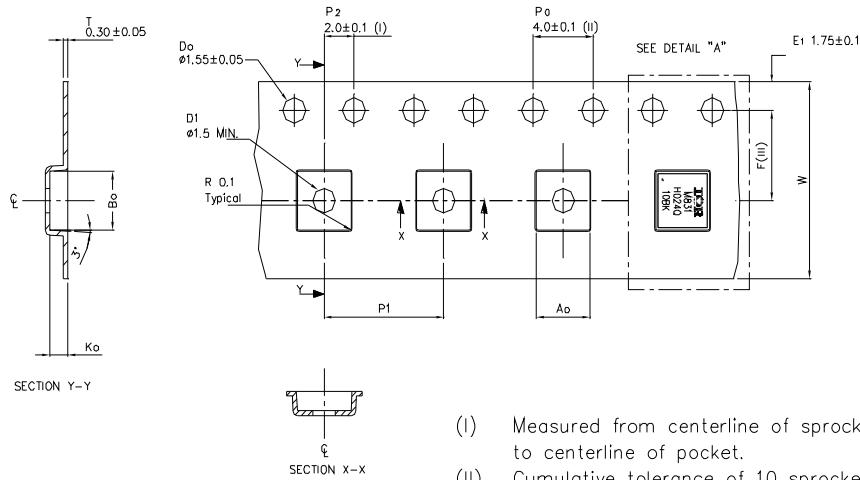
Note: For the most current drawing please refer to IR website at: <http://www.irf.com/package/>

## PQFN Dual 3.3x3.3 Tape and Reel



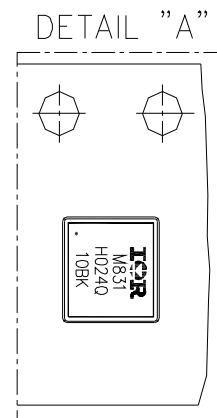
SURFACE RESISTIVITY			
LEGEND	SR RANGE	TYPE	COLOUR
A	BELLOW $10^{12}$	ANTISTATIC	ALL TYPES
B	$10^6$ TO $10^{11}$	STATIC DISSIPATIVE	BLACK ONLY
C	$10^5$ & BELOW $10^5$	CONDUCTIVE (GENERIC)	BLACK ONLY
D	$10^5$ TO $10^9$	CONDUCTIVE (CUSTOM)	BLACK ONLY
E	BELLOW $10^{12}$	COATED ANTISTATIC	ALL COLOR

PRODUCT SPECIFICATION					
TAPE WIDTH	$\phi A$ $\pm 2.0$	$\phi N$ $\pm 2.0$	$W_1$	$W_2$ (MAX)	E (MIN)
08MM	330	100	$8.4^{+1.5}_{-0.0}$	14.4	2.5
12MM	330	100	$12.4^{+2.0}_{-0.0}$	18.4	2.5
16MM	330	100	$16.4^{+2.0}_{-0.0}$	22.4	2.5
24MM	330	100	$24.4^{+2.0}_{-0.0}$	30.4	2.5
32MM	330	100	$32.4^{+2.0}_{-0.0}$	38.4	2.5



Ao	$3.60 \pm 0.1$
Bo	$3.60 \pm 0.1$
Ko	$1.20 \pm 0.1$
F	$5.50 \pm 0.1$
P1	$8.00 \pm 0.1$
W	$12.00 \pm 0.3$

- (I) Measured from centerline of sprocket hole to centerline of pocket.
- (II) Cumulative tolerance of 10 sprocket holes is  $\pm 0.20$ .
- (III) Measured from centerline of sprocket hole to centerline of pocket.
- (IV) Other material available.
- (V) Typical SR of form tape Max  $10^9$  OHM/SQ



Note: For the most current drawing please refer to IR website at: <http://www.irf.com/package/>

**Qualification information<sup>†</sup>**

Qualification level	Industrial <sup>††</sup> (per JEDEC JESD47F <sup>†††</sup> guidelines )	
Moisture Sensitivity Level	PQFN Dual 3.3mm x 3.3mm	MSL1 (per JEDEC J-STD-020D <sup>†††</sup> )
RoHS compliant	Yes	

<sup>†</sup> Qualification standards can be found at International Rectifier's web site  
<http://www.irf.com/product-info/reliability>

<sup>††</sup> Higher qualification ratings may be available should the user have such requirements.  
 Please contact your International Rectifier sales representative for further information:  
<http://www.irf.com/whoto-call/salesrep/>

<sup>†††</sup> Applicable version of JEDEC standard at the time of product release.

**Notes:**

- ① Repetitive rating; pulse width limited by max. junction temperature.
- ② Starting  $T_J = 25^\circ\text{C}$ ,  $L = 2.43\text{mH}$ ,  $R_G = 50\Omega$ ,  $I_{AS} = 2.9\text{A}$ .
- ③ Pulse width  $\leq 400\mu\text{s}$ ; duty cycle  $\leq 2\%$ .
- ④  $R_\theta$  is measured at  $T_J$  of approximately  $90^\circ\text{C}$ .
- ⑤ When mounted on 1 inch square 2 oz copper pad on 1.5x1.5 in. board of FR-4 material.
- ⑥ Calculated continuous current based on maximum allowable junction temperature. Package is limited to 3.4A by wirebond capability.

**Revision History**

Date	Comments
12/16/2013	<ul style="list-style-type: none"> <li>• Updated ordering information to reflect the End-Of-life (EOL) of the mini-reel option (EOL notice #259)</li> <li>• Updated data sheet with new IR corporate template</li> </ul>

International  
 Rectifier

**IR WORLD HEADQUARTERS:** 101 N. Sepulveda Blvd., El Segundo, California 90245, USA  
 To contact International Rectifier, please visit <http://www.irf.com/whoto-call/>